

## End of Life Notification (EOL)

Date : 2016/04/18

Documentation No.: EOL\_097-B22SF-JHCTMA-oV1

**EOL Product :** BON-II(A19nm) MLC 2.5" SATA III SSD supports Fast Erase or Secure Erase

Product Category	2SR (FE/SE)	
Product Status	EOL Product	Alternative Solution
Product Series	BON-II	BON-III
MLC Flash IC nm	Toshiba A19nm MLC	Toshiba 15nm MLC

### Description :

2016/04/14 APRO announced officially EOL for:  
BON-II(A19nm) MLC 2.5" SATA III SSD supports Fast Erase or Secure Erase

This decision was based on BON-II controller does not support Toshiba's advanced MLC 15nm flash IC, and the alternative solution will be BON-III 15nm MLC 2.5" SATA III SSD supports Fast Erase or Secure Erase

We hope this advance notice would help you with sufficient time to arrange the new sample evaluation as early as possible. If you have any questions about this End of Life notification, please contact your APRO account manager.

Please refer to below active date's information for the projects with samples approved previously.

Last Buy : Before 2016/07/31





Last Delivery : Before 2016/10/31

### Alternative Solution :

The alternative solution is: BON-III 15nm MLC 2.5" SATA III SSD supports Fast Erase or Secure Erase

Please see below Appendix A: The part number list comparison for fast reference.

Availability: **Early July in 2016**

Production Management	Engineering Department	Product Management	Sales Department
 4/18	 4/18	 4/18	 4/18
Bonnie Pong	James Hsu	Andy Lin	Allie Chen

**Appendix A:**

Operating Temp.	Capacity	EOL Product	Alternative Solution
Series		BON-II	BON-III
Standard Temp. 0°C~70°C	4GB	NA	TBC
	8GB	NA	
	16GB	NA	
	32GB	SR2SR032G-JHCTMA-UFE (-USE)	
	64GB	SR2SR064G-JHCTMA-UFE (-USE)	
	128GB	SR2SR128G-JHCTMA-UFE (-USE)	
	256GB	SR2SR256G-JHCTMA-UFE (-USE)	
512GB	NA		
Operating Temp.	Capacity	HERMES-F	BON-III
Wide Temp. -40°C~85°C	4GB	NA	TBC
	8GB	NA	
	16GB	NA	
	32GB	WR2SR032G-JHCTMAUFEC (USEC)	
	64GB	WR2SR064G-JHCTMAUFEC (USEC)	
	128GB	WR2SR128G-JHCTMAUFEC (USEC)	
	256GB	WR2SR256G-JHCTMAUFEC (USEC)	
512GB			

**Remarks:**

1. **TMA** vs **TMB**:

**TMA** stands for Toshiba MLC A19nm flash IC

**TMB** stands for Toshiba MLC 15nm flash IC